

## Description

This is 65V 9mΩ N-channel mosfet in a SOP-8L plastic package.

uses 4<sup>th</sup> generation power trench MOSFET technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance. This device is well suited for high efficiency fast switching applications.

## Features

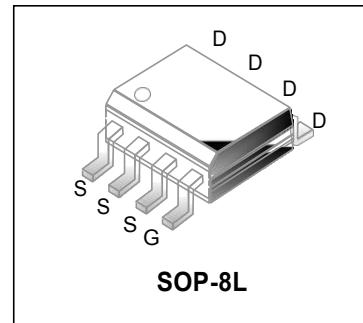
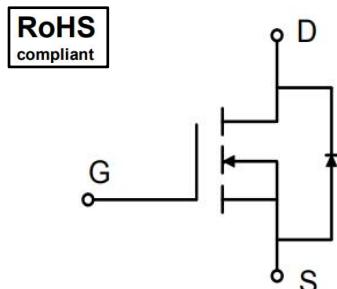
- $V_{DS} = 65V$ ,  $I_D = 14.5A$   
 $R_{DS(on)} < 9m\Omega @ V_{GS} = 10V$   
 $R_{DS(on)} < 13m\Omega @ V_{GS} = 4.5V$
- Green Device Available
- 100% EAS Guaranteed
- Low  $R_{DS(on)}$

## Applications

- Synchronous Rectification
- DC/DC Converter

$V_{DSS}$	$R_{DS(on)}$	$I_D$
65 V	9 mΩ	14.5 A

## Equivalent Circuit & Pinning



**Absolute Maximum Ratings(Ta=25°C)**

<b>Parameter</b>		<b>Symbol</b>	<b>Value</b>	<b>Unit</b>
Drain-Source Voltage		<b>V<sub>DS</sub></b>	65	V
Gate-Source Voltage		<b>V<sub>GS</sub></b>	±20	V
Continuous Drain Current	T <sub>A</sub> =25°C	<b>I<sub>D</sub></b>	14.5	A
	T <sub>A</sub> =100°C		9	
Pulsed Drain Current <sup>1</sup>		<b>I<sub>DM</sub></b>	58	A
Single Pulse Avalanche Energy <sup>2</sup>		<b>E<sub>AS</sub></b>	57.8	mJ
Total Power Dissipation	T <sub>A</sub> =25°C	<b>P<sub>D</sub></b>	3.1	W
Operating Junction and Storage Temperature Range		<b>T<sub>J</sub>, T<sub>STG</sub></b>	-55 to 150	°C

**Thermal Characteristics**

<b>Parameter</b>	<b>Symbol</b>	<b>Value</b>	<b>Unit</b>
Thermal Resistance from Junction-to-Ambient <sup>3</sup>	<b>R<sub>θJA</sub></b>	40	°C/W

## Electrical Characteristics(Ta=25°C)

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	65	-	-	V
Gate-body Leakage Current	$I_{GSS}$	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 65V, V_{GS} = 0V$	-	-	1	$\mu A$
			-	-	100	
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.3	1.7	2.2	V
Drain-Source On-Resistance <sup>4</sup>	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 10A$	-	7	9	$m\Omega$
		$V_{GS} = 4.5V, I_D = 8A$	-	9.5	13	
Forward Transconductance <sup>4</sup>	$g_{fs}$	$V_{DS} = 10V, I_D = 10A$	-	45	-	S
<b>Dynamic Characteristics<sup>5</sup></b>						
Input Capacitance	$C_{iss}$	$V_{DS} = 30V, V_{GS} = 0V, f = 1MHz$	-	1210	-	$pF$
Output Capacitance	$C_{oss}$		-	343	-	
Reverse Transfer Capacitance	$C_{rss}$		-	17	-	
Gate Resistance	$R_g$	$f = 1MHz$	-	1.5	-	$\Omega$
<b>Switching Characteristics<sup>5</sup></b>						
Total Gate Charge	$Q_g$	$V_{GS} = 10V, V_{DS} = 30V, I_D = 10A$	-	21.7	-	$nC$
Gate-Source Charge	$Q_{gs}$		-	3.9	-	
Gate-Drain Charge	$Q_{gd}$		-	4.5	-	
Turn-On Delay Time	$t_{d(on)}$	$V_{GS} = 10V, V_{DD} = 30V, R_G = 3\Omega, I_D = 10A$	-	7.3	-	$ns$
Rise Time	$t_r$		-	8.5	-	
Turn-Off Delay Time	$t_{d(off)}$		-	19.6	-	
Fall Time	$t_f$		-	5.6	-	
Body Diode Reverse Recovery Time	$t_{rr}$	$I_f = 10A, dI/dt = 100A/\mu s$	-	34	-	$ns$
Body Diode Reverse Recovery Charge	$Q_{rr}$		-	17	-	$nC$
<b>Drain-Source Body Diode Characteristics</b>						
Diode Forward Voltage <sup>4</sup>	$V_{SD}$	$I_s = 10A, V_{GS} = 0V$	-	-	1.2	V
Continuous Source Current	$T_A = 25^\circ C$	$I_s$	-	-	14.5	A

## Notes:

- Repetitive rating, pulse width limited by junction temperature  $T_{J(MAX)} = 150^\circ C$
- The EAS data shows Max. rating . The test condition is  $V_{DD} = 25V, V_{GS} = 10V, L = 0.4mH, I_{AS} = 17A$ .
- The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper, The value in any given application depends on the user's specific board design.
- The data tested by pulsed , pulse width  $\leq 300\mu s$  , duty cycle  $\leq 2\%$ .
- This value is guaranteed by design hence it is not included in the production test.

## Electrical Characteristic Curve

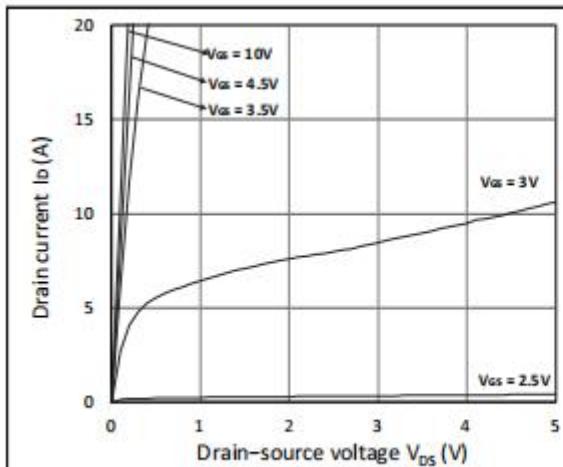


Figure 1. Output Characteristics

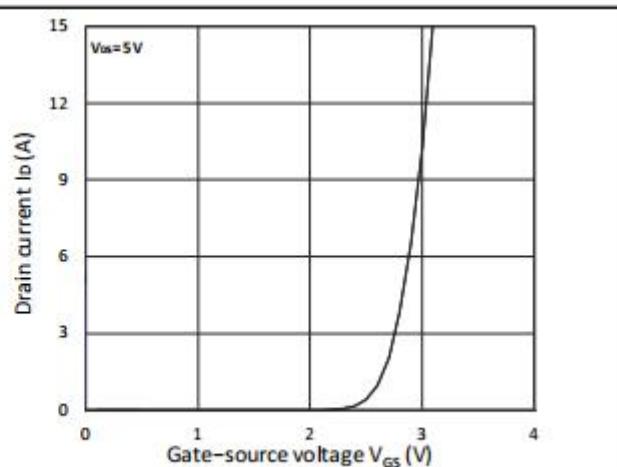


Figure 2. Transfer Characteristics

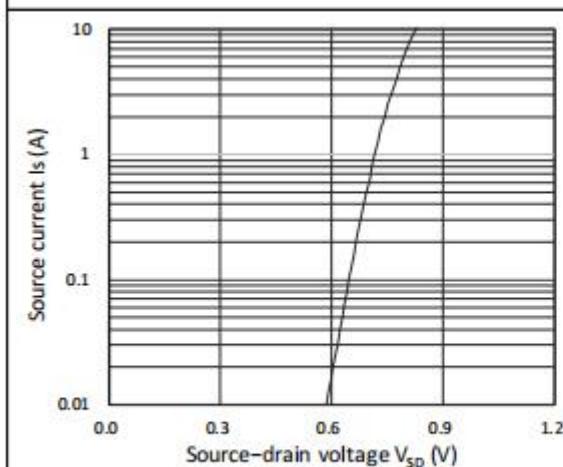
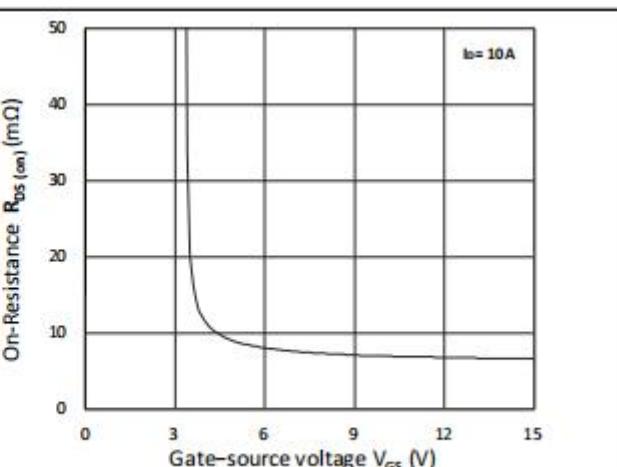
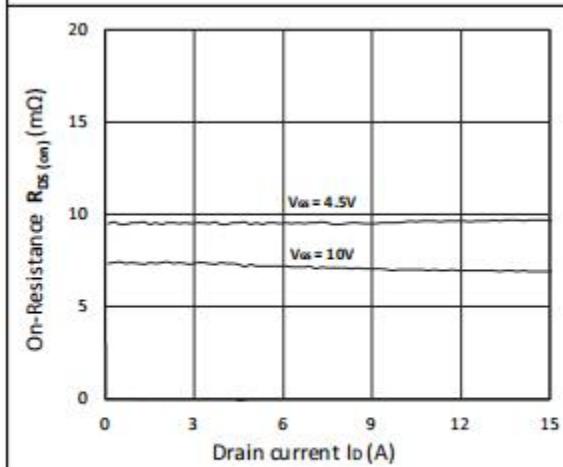
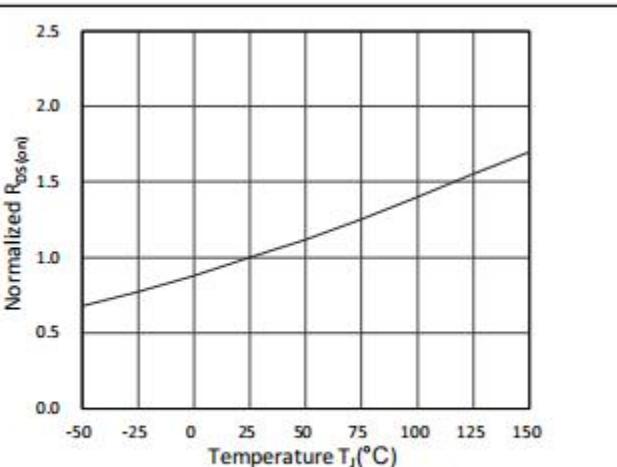


Figure 3. Forward Characteristics of Reverse

Figure 4.  $R_{DS(on)}$  vs.  $V_{GS}$ Figure 5.  $R_{DS(on)}$  vs.  $I_D$ Figure 6. Normalized  $R_{DS(on)}$  vs. Temperature

## Electrical Characteristic Curve

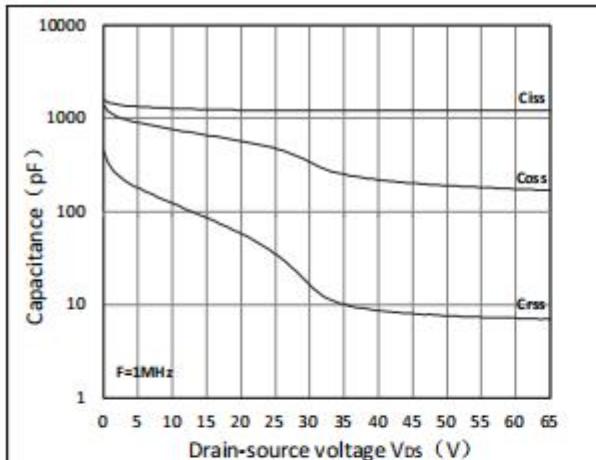


Figure 7. Capacitance Characteristics

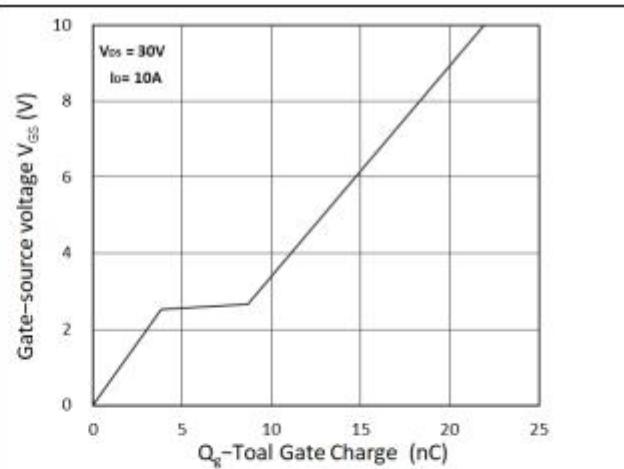


Figure 8. Gate Charge Characteristics

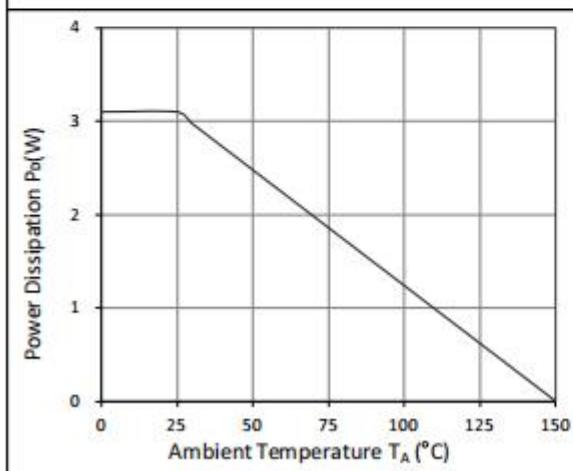


Figure 9. Power Dissipation

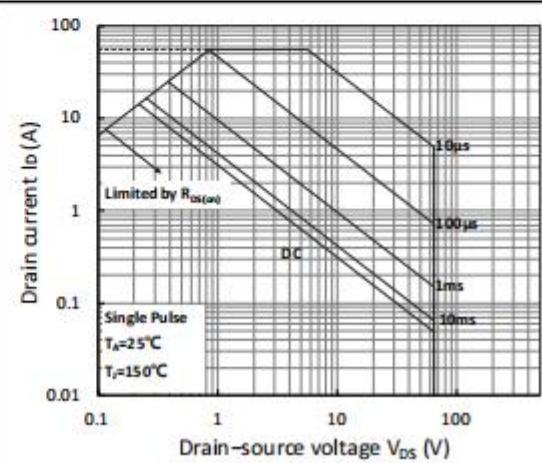


Figure 10. Safe Operating Area

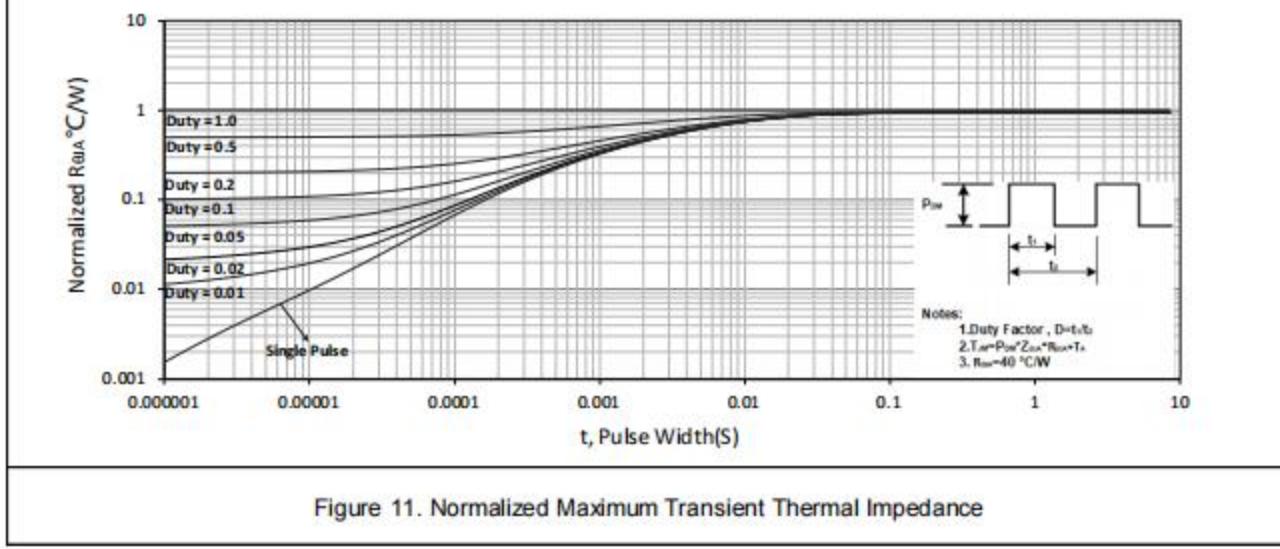


Figure 11. Normalized Maximum Transient Thermal Impedance

## Test Circuit

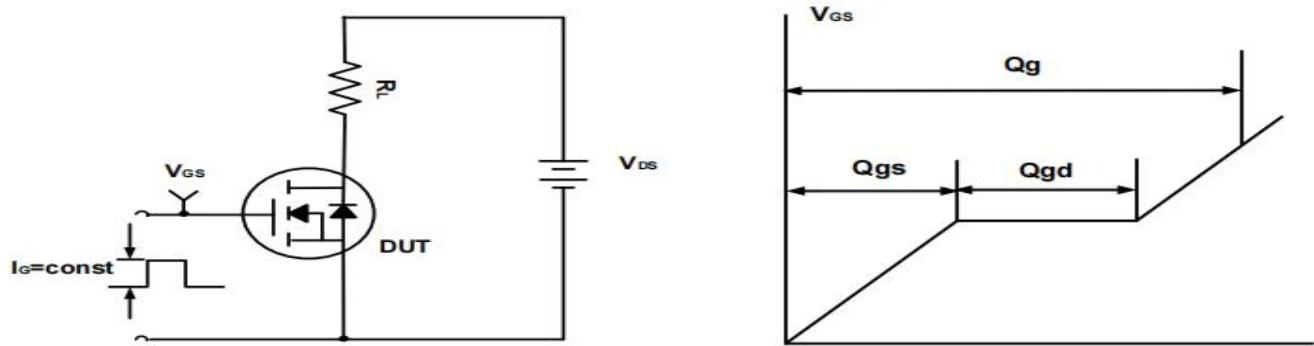


Figure A. Gate Charge Test Circuit &amp; Waveforms

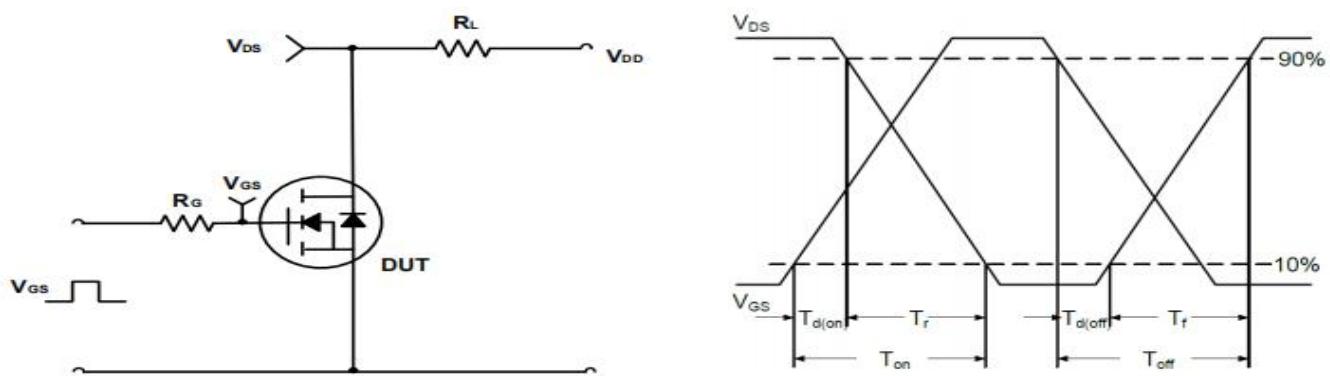


Figure B. Switching Test Circuit &amp; Waveforms

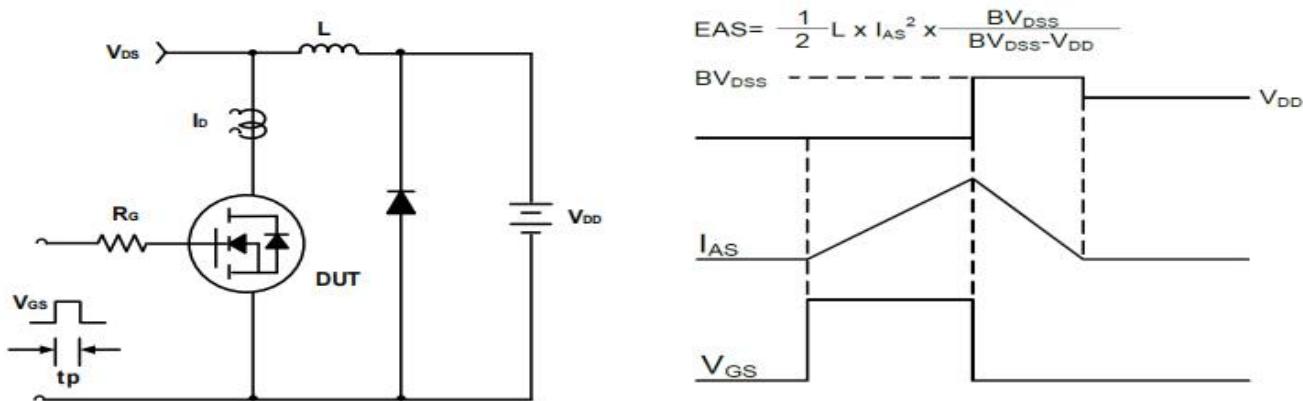
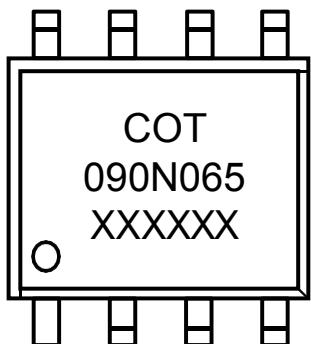


Figure C. Unclamped Inductive Switching Circuit &amp; Waveforms

### Marking Instructions

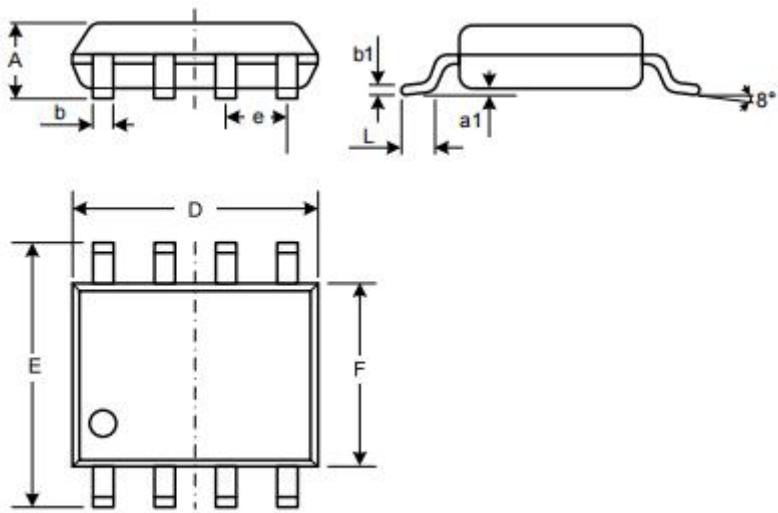


090N065 = Device code  
XXXXXX = Date code

### Ordering Information

Part	Package	Marking	Packing method
CT090N065SA	SOP-8L	090N065	Tape and Reel

## Mechanical Dimensions for SOP-8L



## COMMON DIMENSIONS

SYMBOL	MM	
	MIN	MAX
A	1.35	1.75
a1	0.05	0.25
b	0.31	0.51
b1	0.16	0.25
D	4.70	5.15
E	5.75	6.25
e	1.07	1.47
F	3.70	4.10
L	0.40	1.27